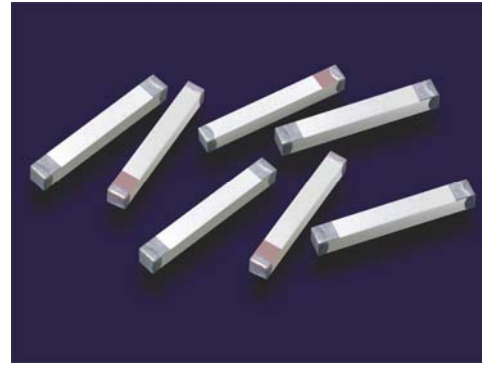


# AT8010 Series

## Multilayer Chip Antenna



### Features

- ❖ Monolithic SMD with small, low-profile and light-weight type.
- ❖ Wide bandwidth
- ❖ RoHS compliant

### Applications

- ❖ 2.4GHz WLAN, Home RF, Bluetooth Modules, BAN, etc.

### Specifications

Part Number	Operating Frequency (MHz)	Peak Gain (dBi typ.)	Average Gain (dBi typ.)	VSWR	Impedance
<b>AT8010-E2R9HAA_</b>	2360~2500	2.5 (XZ-V)	0.5 (XZ-V)	2 max.	50 Ω

Q'ty/Reel (pcs) : 1,000 pcs  
 Operating Temperature Range : -40 ~ +125 °C  
 Storage Temperature Range : -40 ~ +85 °C  
 Storage Period : 12 months max.  
**Power Capacity : 3W max. (Rated Voltage: 12V )**

### Part Number

AT   8010   -   E   2R9   HAA   □   /LF  
 ①   ②   ③   ④   ⑤   ⑥   ⑦

① Type	AT : Antenna	② Dimensions ( L x W )	8.0 x 1.0 mm
③ Material Code	E	④ Initial center frequency	2R9=2900MHz
⑤ Specification Code	HAA	⑥ Packaging	T: Tape & Reel B: Bulk
⑦ Soldering	/LF=lead-free		

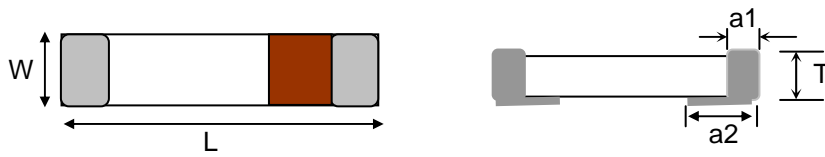
### Terminal Configuration



No.	Terminal Name	No.	Terminal Name
①	Feeding Point	②	NC

**Dimensions and Recommended PC Board Pattern**

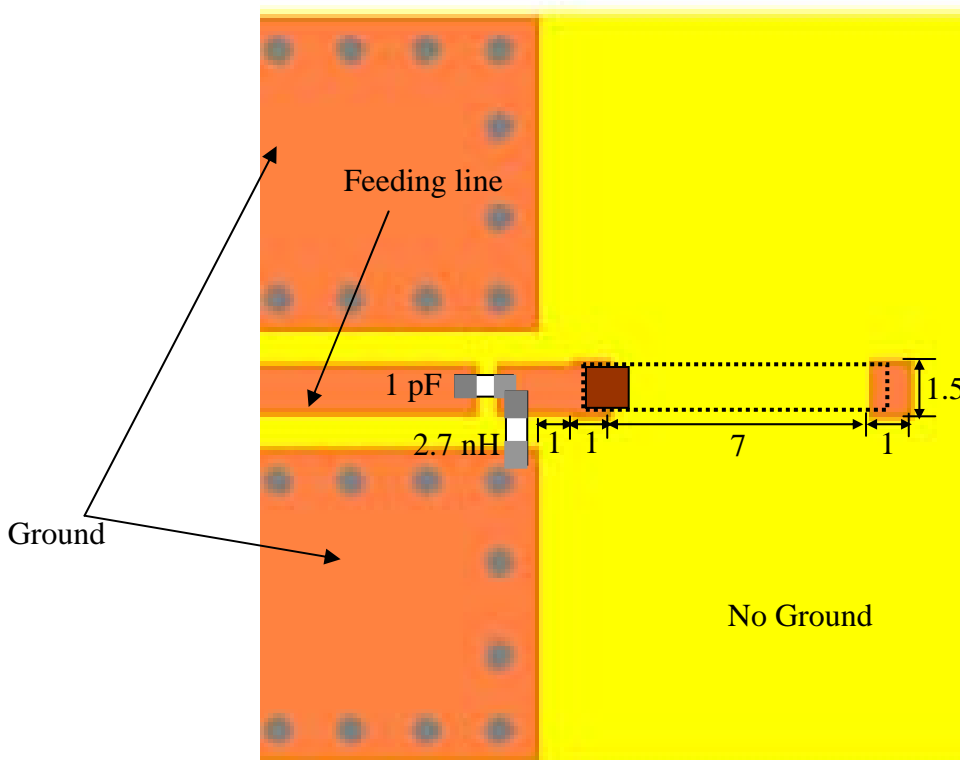
Unit : mm



Mark	L	W	T	a1	a2
Dimensions	8.0±0.2	1.0±0.2	1.0±0.2	0.5±0.2	1.0±0.2

**The Recommended PC Board layout – Type A**

❖ With Matching Circuits (Unit in mm)

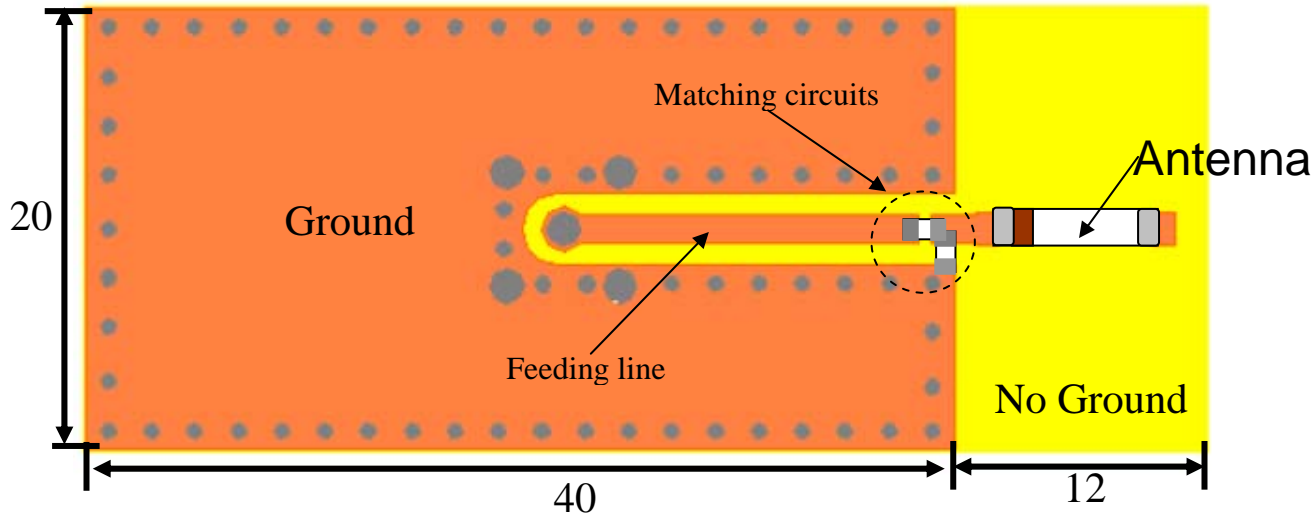


(Matching circuit and component values will be different, depending on PCB layout)

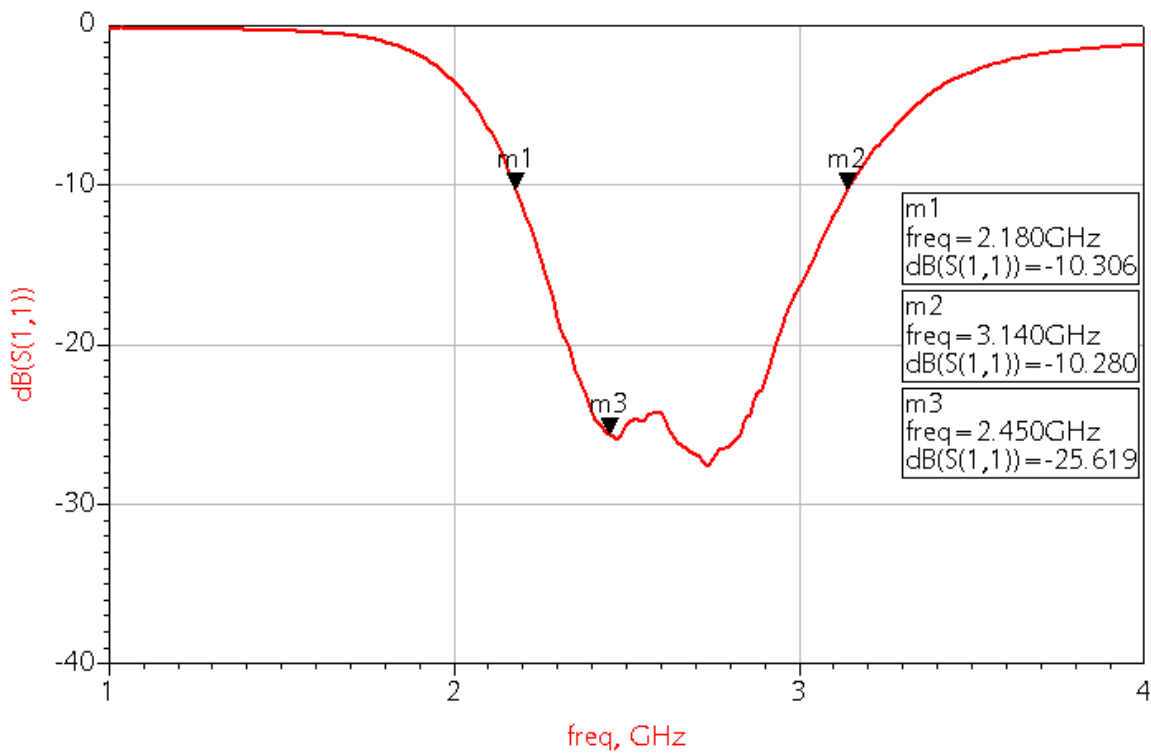
\*Line width should be designed to match 50Ω characteristic impedance, depending on PCB material and thickness.

**Typical Electrical Characteristics (T=25°C)**

❖ Test Board – Type A (Unit in mm)

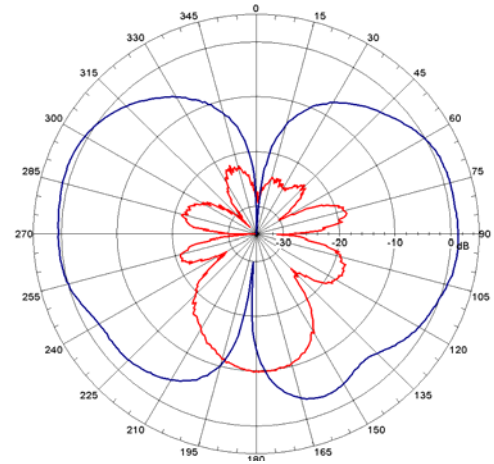
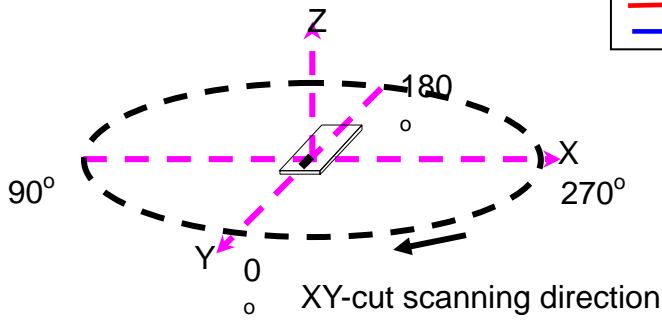


❖ Return Loss / With Matching Circuits

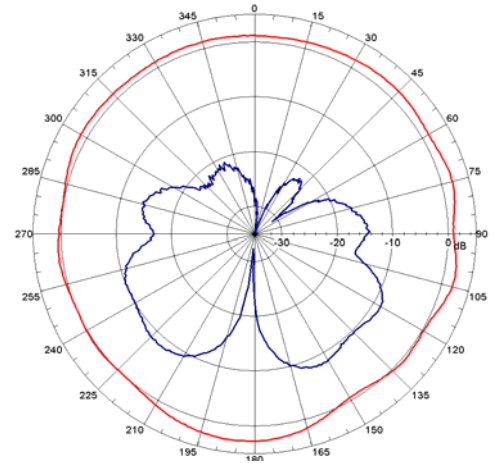
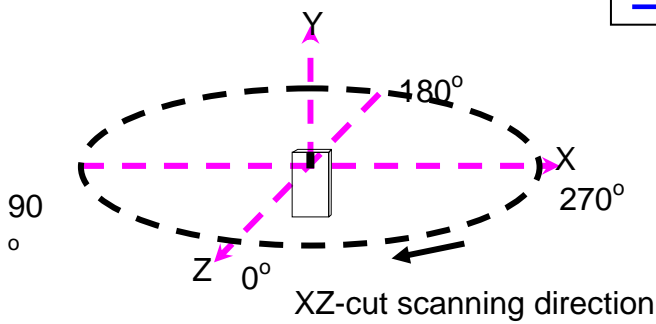


❖ Radiation Patterns

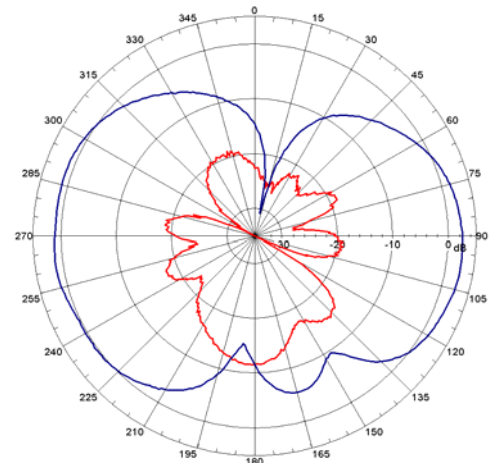
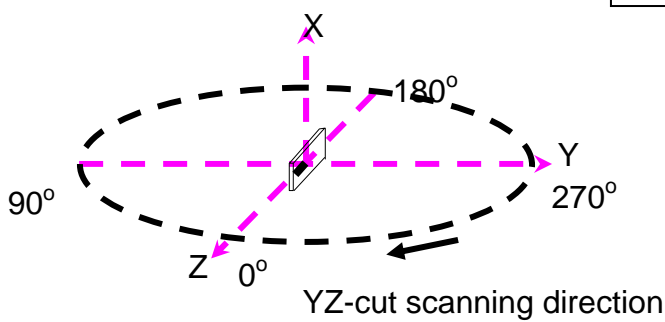
XY-V/XY-H



XZ-V/XZ-H

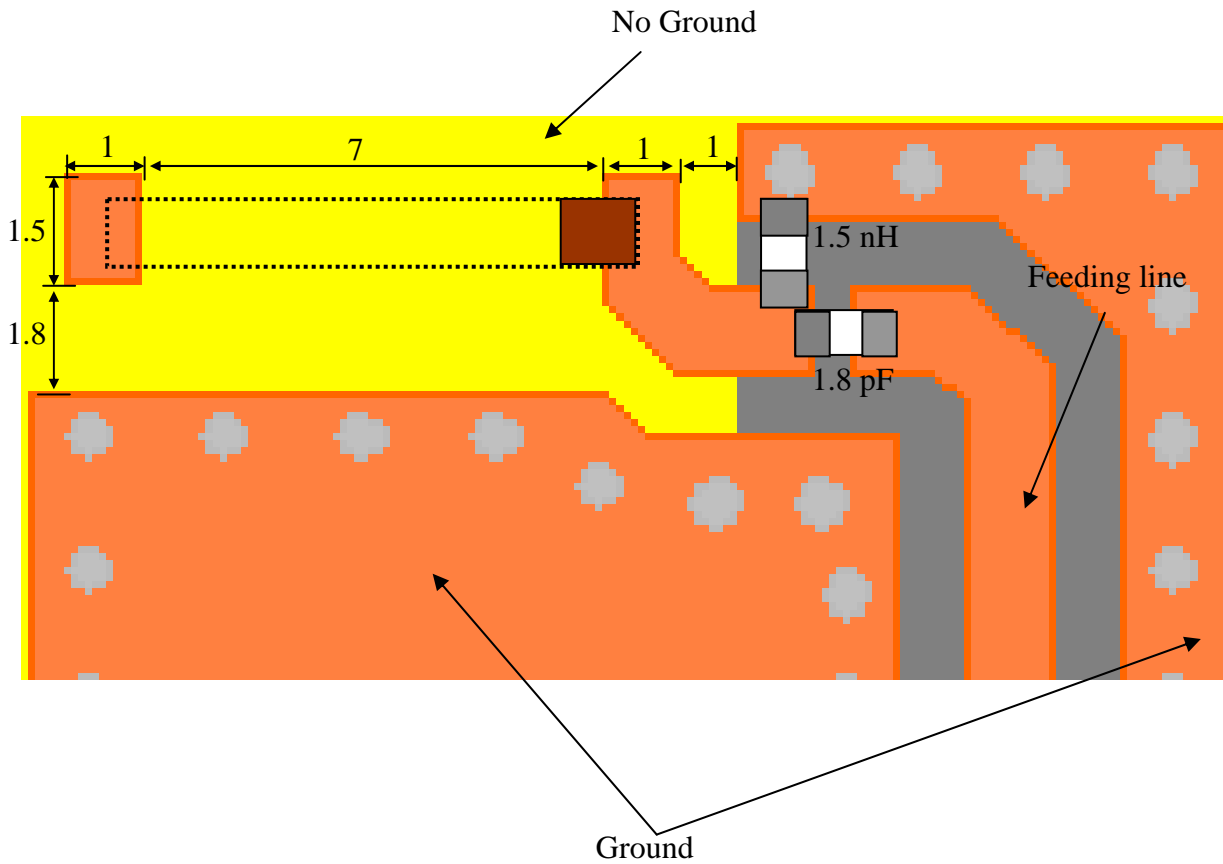


YZ-V/YZ-H



**The Recommended PC Board layout – Type B**

❖ With Matching Circuits (Unit in mm)

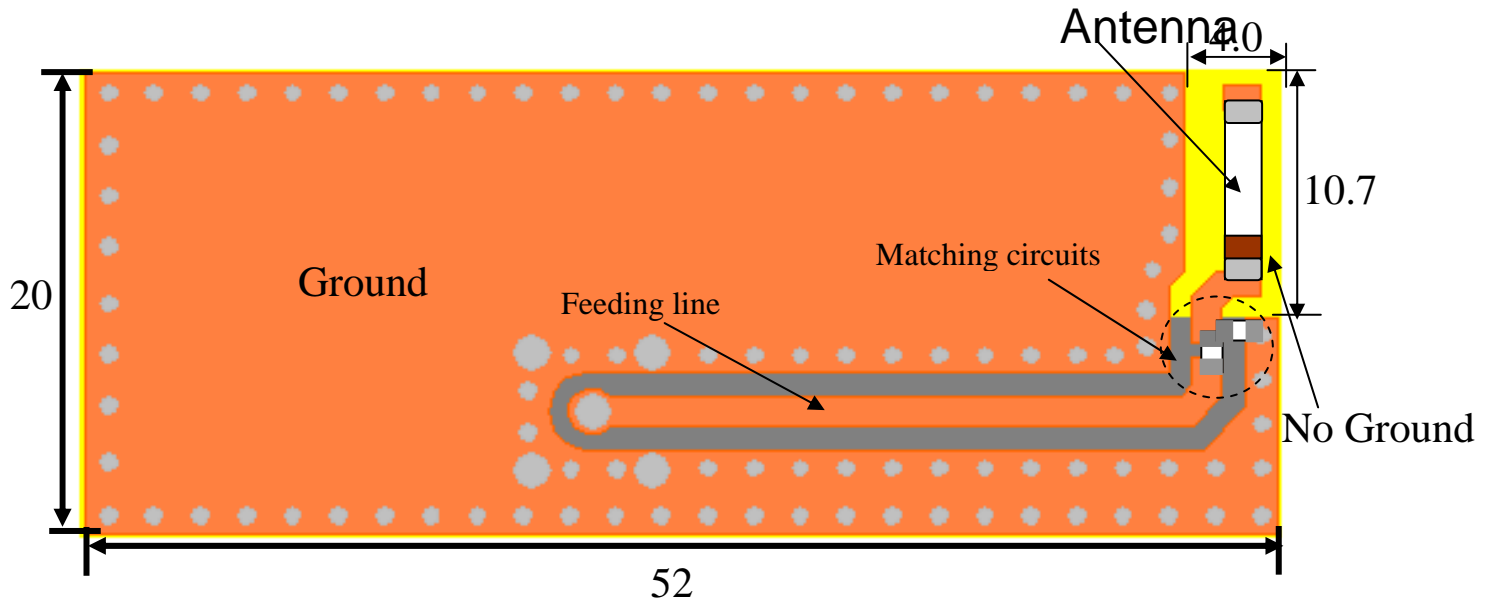


(Matching circuit and component values will be different, depending on PCB layout)

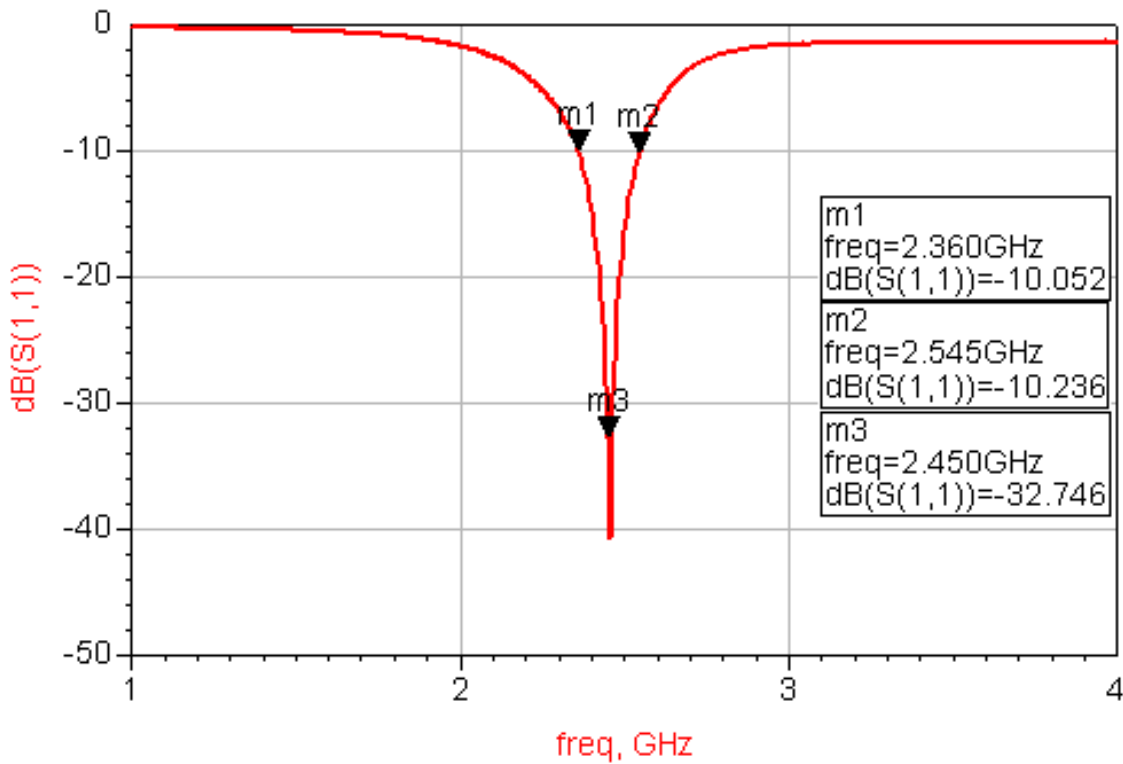
\*Line width should be designed to match 50Ω characteristic impedance, depending on PCB material and thickness.

**Typical Electrical Characteristics (T=25°C)**

❖ Test Board – Type B (Unit in mm)

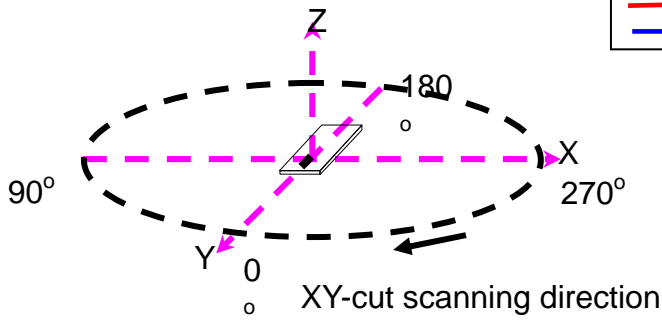


❖ Return Loss / With Matching Circuits

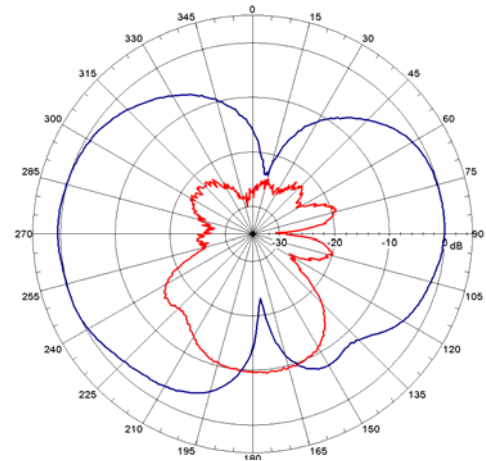


❖ Radiation Patterns

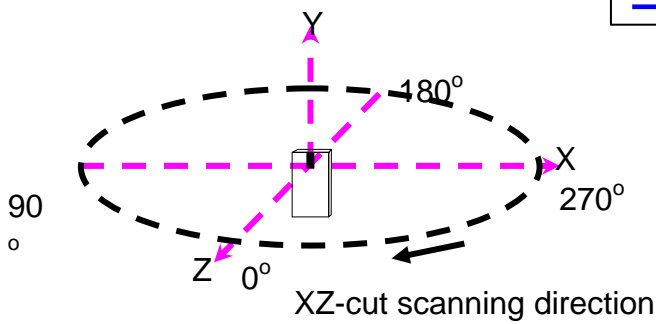
XY-V/XY-H



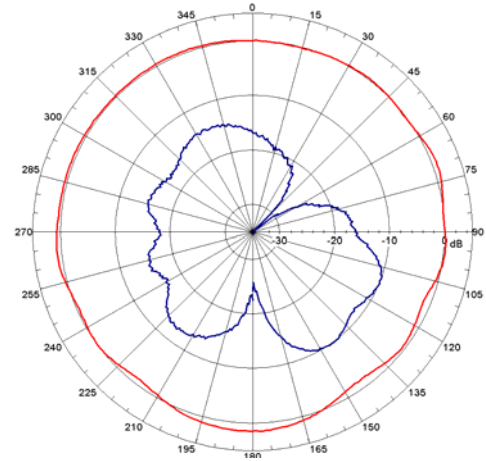
XY cut @2.45GHz  
— Vertical  
— Horizontal



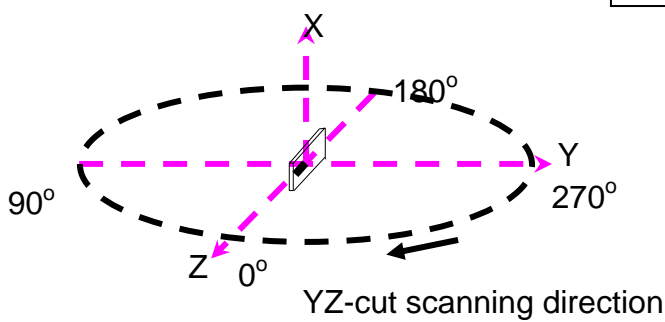
XZ-V/XZ-H



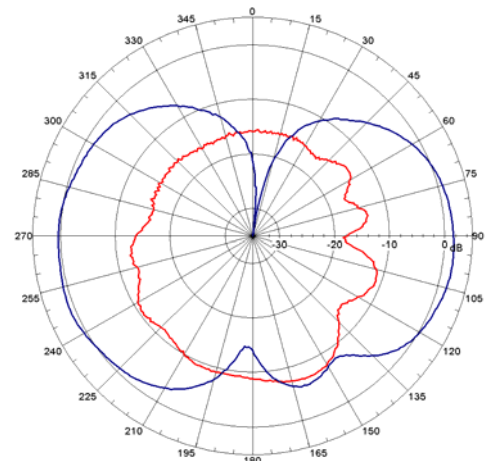
XZ cut @2.45GHz  
— Vertical  
— Horizontal



YZ-V/YZ-H

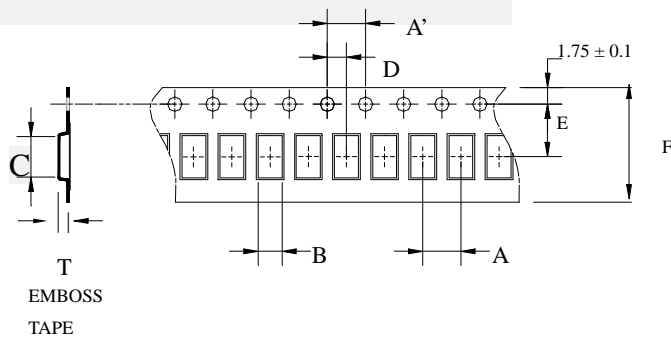


YZ cut @2.45GHz  
— Vertical  
— Horizontal



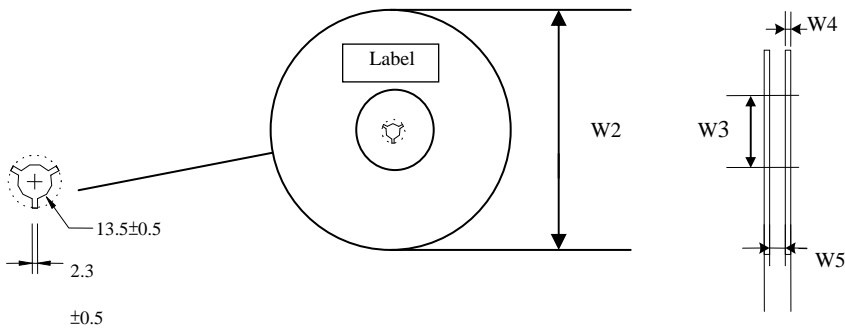
## Taping Specifications

### ❖ Tape & Reel Dimensions (Unit: mm) vs. Quantity (pcs)



Type	A	A'	B	C	D	E	F	T	Quantity/per reel	Tape material
AT8010	4.0±	4.0±	1.3±	8.35±	2.0±	7.5±	16.0±	1.08±	1,000pcs	Plastic (Embossed)
	0.1	0.1	0.1	0.1	0.05	0.1	0.1	0.05		

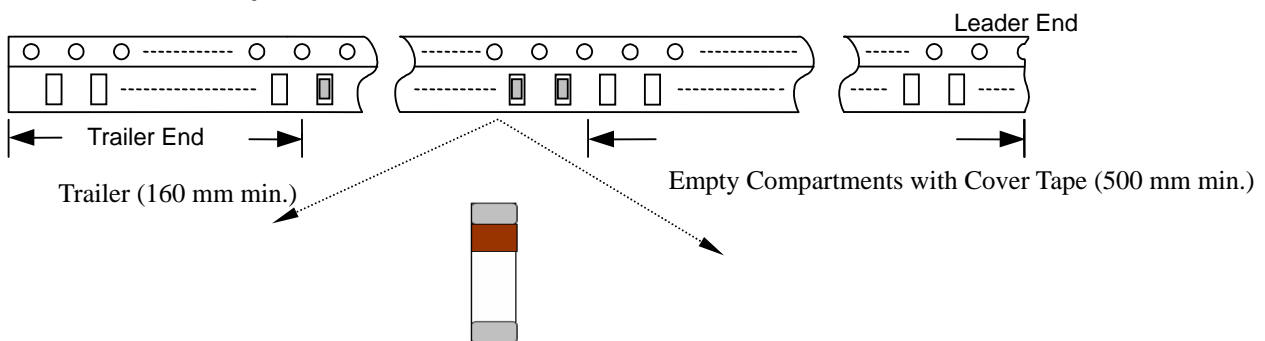
### ❖ Reel Dimensions (Unit: mm)



Label: Customer's Name,  
ACX P/N, Q'ty, Date,  
ACX Corp.

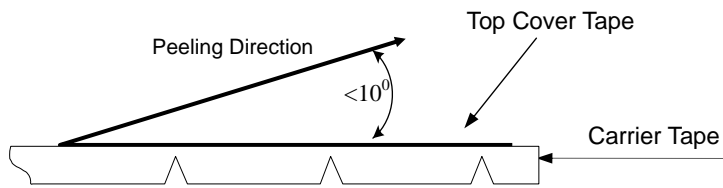
Type	W2	W3	W4	W5
AT8010	178±1	60±1	1.4±0.2	17±0.5

### ❖ Leader and Trailer Tape





❖ Peel-off Force



Peel-off force should be in the range of 0.2 – 1.20 N at a peel-off speed of  $300 \pm 10$  mm/min .

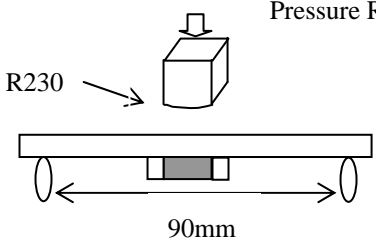
❖ Storage Conditions

- (1) Temperature:  $+5 \sim 35^{\circ}\text{C}$  , relative humidity (RH): 45~75%.
- (2) Non-corrosive environment

**Notes**

❖ The contents of this data sheet are subject to change without notice. Please confirm the specifications and delivery conditions when placing your order.

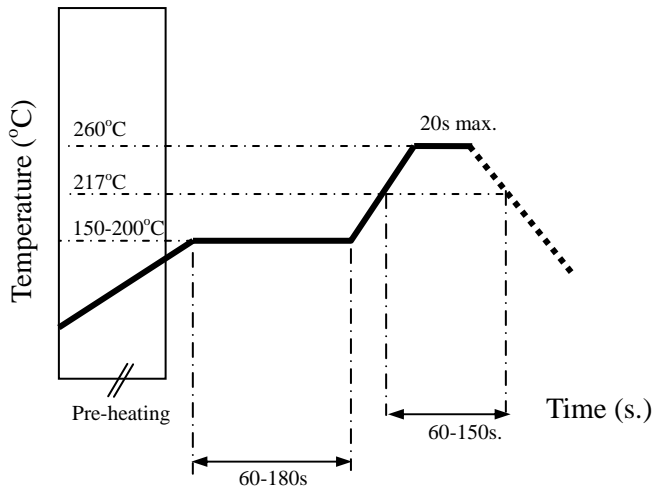
## Mechanical & Environmental Characteristics

Item	Requirements	Procedure
Solderability	<ol style="list-style-type: none"> <li>No apparent damage</li> <li>More than 95% of the terminal electrode shall be covered with new solder</li> </ol>	<ol style="list-style-type: none"> <li>Preheat: <math>120 \pm 5^\circ\text{C}</math></li> <li>Solder: <math>245 \pm 5^\circ\text{C}</math> for <math>5 \pm 1</math> sec</li> </ol>
Soldering strength (Termination Adhesion)	<ol style="list-style-type: none"> <li>1kg minimum</li> </ol>	<ol style="list-style-type: none"> <li>Solder specimen onto test jig.</li> <li>Apply push force at 0.5mm/s until electrode pads are peeled off or ceramic are broken. Pushing force is applied to longitude direction</li> </ol>
Deflection (Substrate Bending)	<ol style="list-style-type: none"> <li>No apparent damage</li> </ol>	<ol style="list-style-type: none"> <li>Solder specimen onto test jig (FR4, 0.8mm) using the recommend soldering profile.</li> <li>Apply a bending force of 1mm deflection</li> </ol> 
Heat/Humidity Resistance	<ol style="list-style-type: none"> <li>No apparent damage</li> <li>Fulfill the electrical specification after test</li> </ol>	<ol style="list-style-type: none"> <li>Temperature: <math>85 \pm 2^\circ\text{C}</math></li> <li>Humidity: 90% ~ 95% RH</li> <li>Duration: <math>1000 \pm 48</math>hrs</li> <li>Recovery: 1-2hrs</li> </ol>
Thermal shock (Temperature Cycle)	<ol style="list-style-type: none"> <li>No apparent damage</li> <li>Fulfill the electrical specification after test</li> </ol>	<ol style="list-style-type: none"> <li>One cycle/step 1 : <math>125 \pm 5^\circ\text{C}</math> for 30 min step 2 : <math>-40 \pm 5^\circ\text{C}</math> for 30 min</li> <li>No of cycles : 100</li> <li>Recovery: 1-2 hrs</li> </ol>
Low Temperature Resistance	<ol style="list-style-type: none"> <li>No apparent damage</li> <li>Fulfill the electrical specification after test</li> </ol>	<ol style="list-style-type: none"> <li>Temperature: <math>-40 \pm 5^\circ\text{C}</math></li> <li>Duration: <math>500 \pm 24</math>hrs</li> <li>Recovery: 1-2hrs</li> </ol>

## Soldering Conditions

### ❖ Typical Soldering Profile for Lead-free Process

Reflow Soldering :



## Notes

❖ The contents of this data sheet are subject to change without notice. Please confirm the specifications and delivery conditions when placing your order.

### **Advanced Ceramic X Corp.**

16 Tzu Chiang Road, Hsinchu Industrial District Hsinchu Hsien 303, Taiwan

TEL:886-3-5987008 FAX:886-3-5987001

E-mail: [acx@acxc.com.tw](mailto:acx@acxc.com.tw) <http://www.acxc.com.tw>